

Absolute Maximum Ratings (Ta=25°C)

Parameter		Symbol	Rating	Unit
Input	Forward current	I_F	25	mA
	Peak forward current (50% duty, 1ms P.W)	I_{FP}	50	mA
	Peak transient current ($\leq 1\mu s$ P.W, 300pps)	I_{Ftrans}	1	A
	Reverse voltage	V_R	5	V
	Power dissipation	P_{IN}	45	mW
Output	Power dissipation	P_O	100	mW
	Emitter-Base reverse voltage	6N135 6N136 V_{EBR}	5	V
	Base current	6N135 6N136 I_B	5	mA
	Average Output current	$I_{O(AVG)}$	8	mA
	Peak Output current	$I_{O(PK)}$	16	mA
	Output voltage	V_O	-0.5 to 20	V
	Supply voltage	V_{CC}	-0.5 to 30	V
	Total Power Dissipation	P_{TOT}	200	mW
Isolation Voltage*1		V_{ISO}	5000	Vrms
Operating Temperature		T_{OPR}	-55 to 100	°C
Storage Temperature		T_{STG}	-55 to 125	°C
Soldering Temperature*2		T_{SOL}	260	°C

Notes:

*1 AC for 1 minute, R.H.= 40 ~ 60% R.H. In this test, pins 1, 2, 3, 4 are shorted together, and pins 5, 6, 7, 8 are shorted together.

*2 For 10 seconds

Electrical Characteristics (T_A=0 to 70°C unless specified otherwise)

Input

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Forward Voltage	V _F	-	1.45	1.8	V	I _F =16mA
Reverse Voltage	V _R	5.0	-	-	V	I _R = 10μA
Temperature coefficient of forward voltage	ΔV _F /ΔT _A	-	-1.9	-	mV/°C	I _F =16mA

Output

Parameter	Symbol	Min	Typ.	Max.	Unit	Condition
Logic High Output Current	I _{OH}	-	0.001	0.5	μA	I _F =0mA, V _O =V _{CC} =5.5V, T _A =25°C
		-	0.01	1		I _F =0mA, V _O =V _{CC} =15V, T _A =25°C
		-	-	50		I _F =0mA, V _O =V _{CC} =15V
Logic Low Supply Current	I _{CCL}	-	140	200	μA	I _F =16mA, V _O =Open, V _{CC} =15V
Logic High Supply Current	I _{CCH}	-	0.01	1	μA	I _F =0mA, V _O =Open, V _{CC} =15V, T _A =25°C
		-	-	2		I _F =0mA, V _O =Open, V _{CC} =15V

Transfer Characteristics (T_A=0 to 70°C unless specified otherwise)

Parameter	Symbol	Min	Typ.	Max.	Unit	Condition	
Current Transfer Ratio	6N135	7	-	50	%	I _F = 16mA ,V _O = 0.4V, V _{CC} =4.5V, T _A =25°C	
	6N136	19	-	50			
	EL4502 EL4503						
	6N135	5	-	-		I _F = 16mA ,V _O = 0.5V, V _{CC} =4.5V	
	6N136	15	-	-			
	EL4502 EL4503						
Logic Low Output Voltage	6N135	-	0.18	0.4	V	I _F = 16mA ,I _O = 1.1mA, V _{CC} =4.5V, T _A =25°C	
	6N136	-	0.25	0.4		I _F = 16mA ,I _O = 3mA, V _{CC} =4.5V, T _A =25°C	
	EL4502 EL4503						
	6N135	-	-	0.5		I _F = 16mA ,I _O =0.8mA, V _{CC} =4.5V	
	6N136 EL4502 EL4503	-	-	0.5		I _F = 16mA ,I _O =2.4mA, V _{CC} =4.5V	

Switching Characteristics ($T_A=0$ to 70°C unless specified otherwise, $I_F=16\text{mA}$, $V_{CC}=5\text{V}$)

Parameter	Symbol	Min	Typ.	Max.	Unit	Condition
Propagation Delay Time to Logic Low (Fig.8)	6N135 6N136 EL4502 EL4503	TPHL	-	0.35	1.5	$R_L=4.1\text{K}\Omega$, $T_A=25^\circ\text{C}$
			-	-	2.0	$R_L=4.1\text{K}\Omega$
			-	0.35	0.8	$R_L=1.9\text{K}\Omega$, $T_A=25^\circ\text{C}$
			-	-	1.0	$R_L=1.9\text{K}\Omega$
Propagation Delay Time to Logic High (Fig.8)	6N135 6N136 EL4502 EL4503	TPLH	-	0.5	1.5	$R_L=4.1\text{K}\Omega$, $T_A=25^\circ\text{C}$
			-	-	2.0	$R_L=4.1\text{K}\Omega$
			-	0.3	0.8	$R_L=1.9\text{K}\Omega$, $T_A=25^\circ\text{C}$
			-	-	1.0	$R_L=1.9\text{K}\Omega$
Common Mode Transient Immunity at Logic High (Fig.9)* ³	6N135	CM_H	1,000	-	-	$I_F=0\text{mA}$, $V_{CM}=10\text{Vp-p}$, $R_L=4.1\text{K}\Omega$, $T_A=25^\circ\text{C}$
	6N136 EL4502		1,000	-	-	$I_F=0\text{mA}$, $V_{CM}=10\text{Vp-p}$, $R_L=1.9\text{K}\Omega$, $T_A=25^\circ\text{C}$
	EL4503		15000	20000	-	$I_F=0\text{mA}$, $V_{CM}=1500\text{Vp-p}$, $R_L=1.9\text{K}\Omega$, $T_A=25^\circ\text{C}$
Common Mode Transient Immunity at Logic Low (Fig.9)* ³	6N135	CM_L	1,000	-	-	$I_F=16\text{mA}$, $V_{CM}=10\text{Vp-p}$, $R_L=4.1\text{K}\Omega$, $T_A=25^\circ\text{C}$
	6N136 EL4502		1,000	-	-	$I_F=16\text{mA}$, $V_{CM}=10\text{Vp-p}$, $R_L=1.9\text{K}\Omega$, $T_A=25^\circ\text{C}$
	EL4503		15000	20000	-	$I_F=16\text{mA}$, $V_{CM}=1500\text{Vp-p}$, $R_L=1.9\text{K}\Omega$, $T_A=25^\circ\text{C}$

* Typical values at $T_A = 25^\circ\text{C}$

Typical Electro-Optical Characteristics Curves

Fig.1 Forward Current vs. Forward Voltage

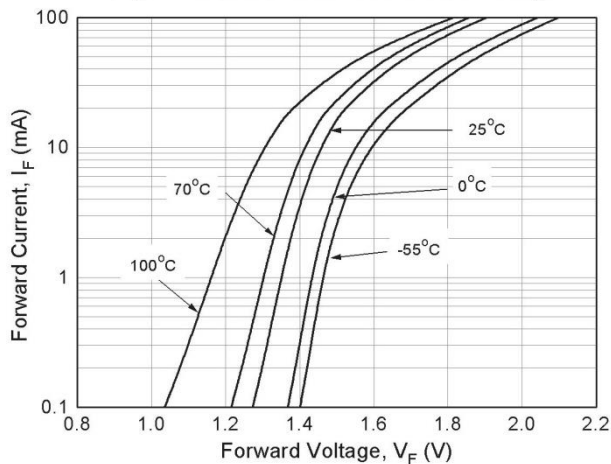


Fig.2 Normalized Current Transfer Ratio vs. Forward Current

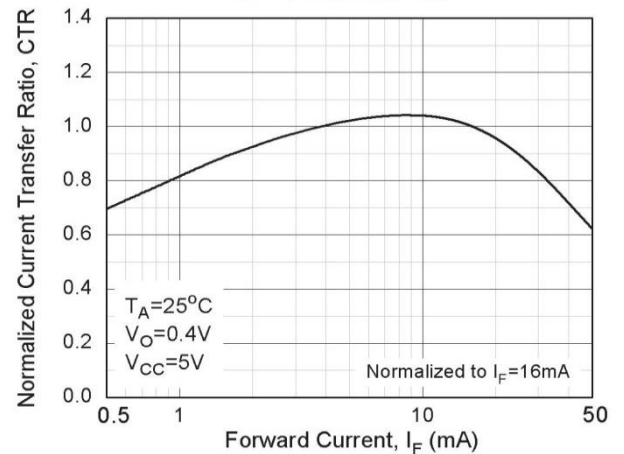


Fig.3 Normalized Current Transfer Ratio vs. Ambient Temperature

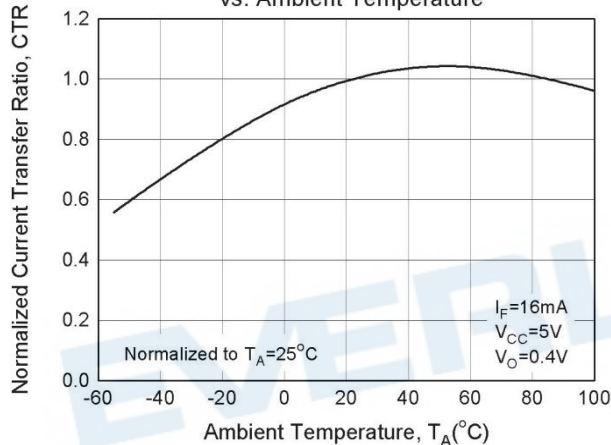


Fig.4 Output Current vs Output Voltage

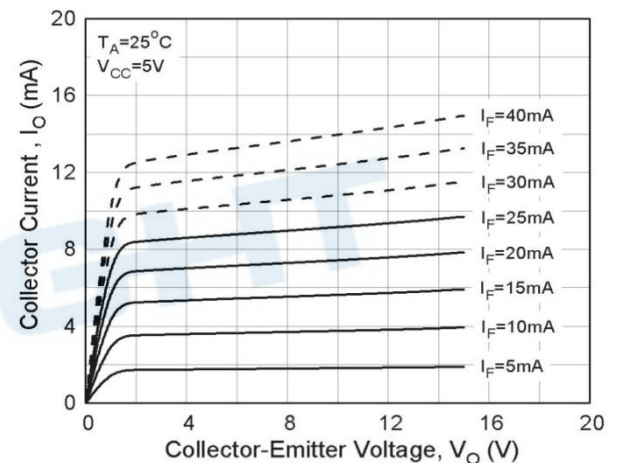


Fig.5 Logic High Output Current vs. Temperature

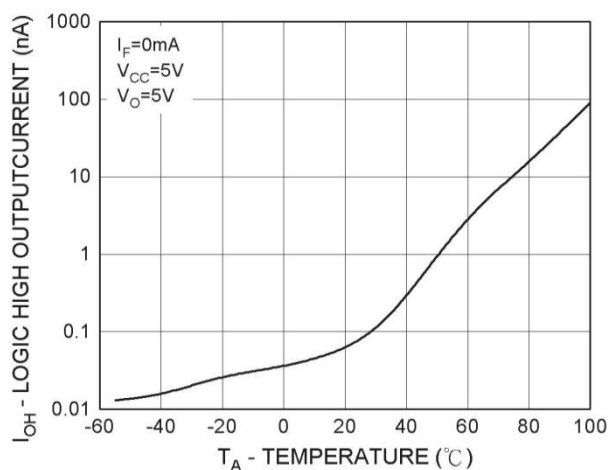


Fig.6 Propagation Delay vs. Load Resistance

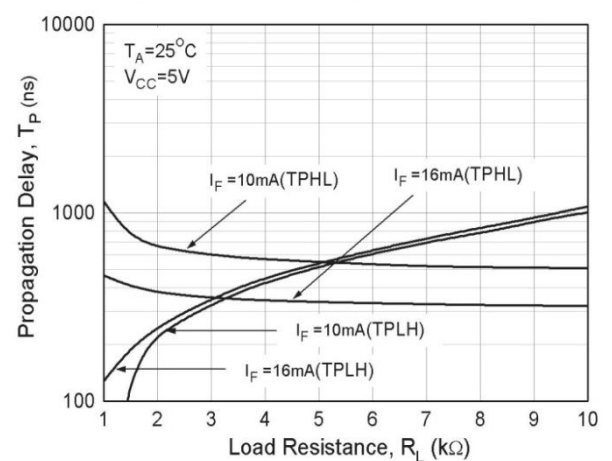


Fig.7 Propagation Delay vs. Temperature

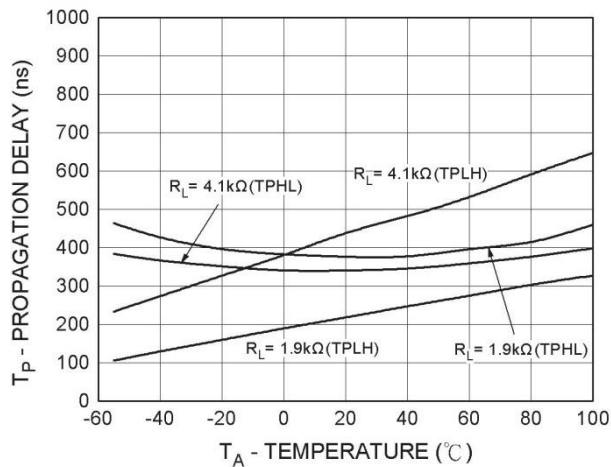


Figure 8 Switching Time Test Circuit & Waveform

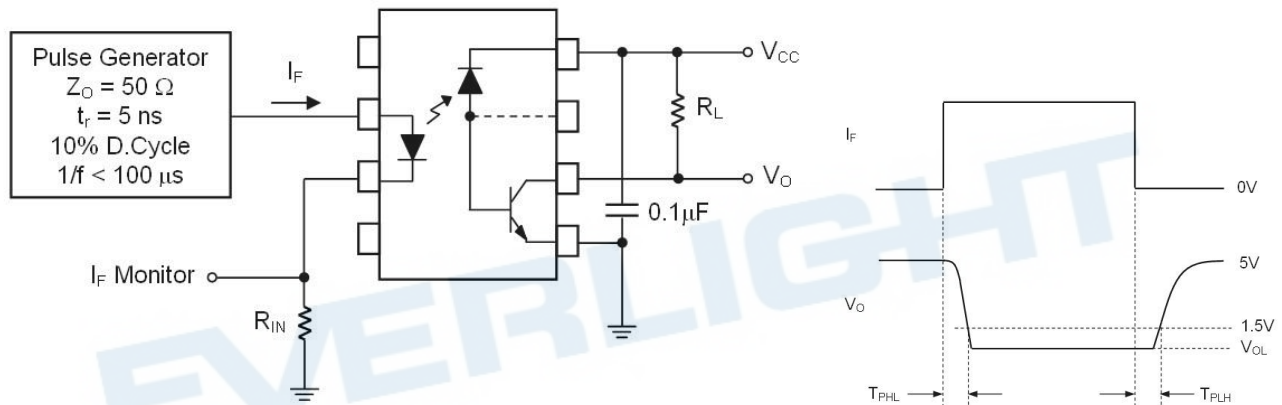
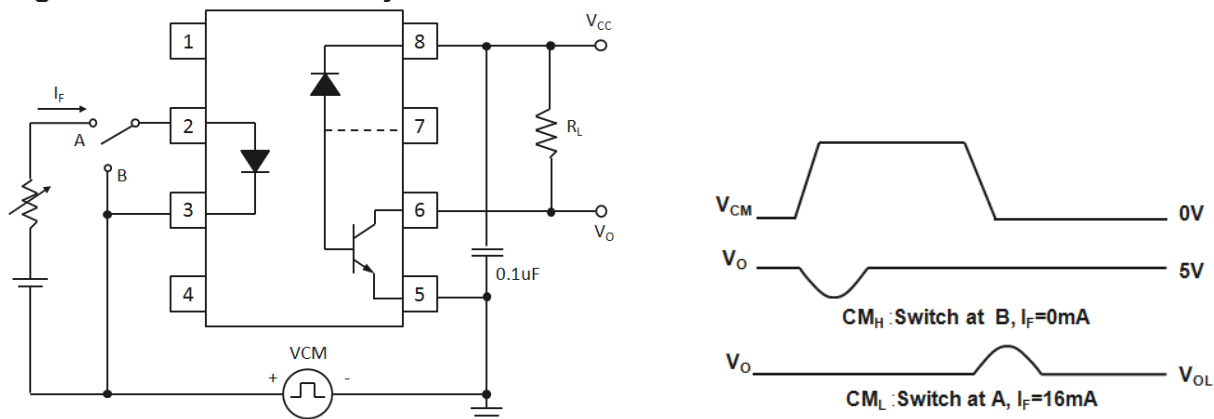


Figure 9 Transient Immunity Test Circuit & Waveform



Note:

*3 Common mode transient immunity in logic high level is the maximum tolerable (positive) dV_{cm}/dt on the leading edge of the common mode pulse signal VCM, to assure that the output will remain in a logic high state (i.e., $V_O > 2.0V$).

Common mode transient immunity in logic low level is the maximum tolerable (negative) dV_{cm}/dt on the trailing edge of the common mode pulse signal, VCM, to assure that the output will remain in a logic low state (i.e., $V_O < 0.8V$).

Order Information

Part Number

6N13XY(Z)-V

or

EL450XY(Z)-V

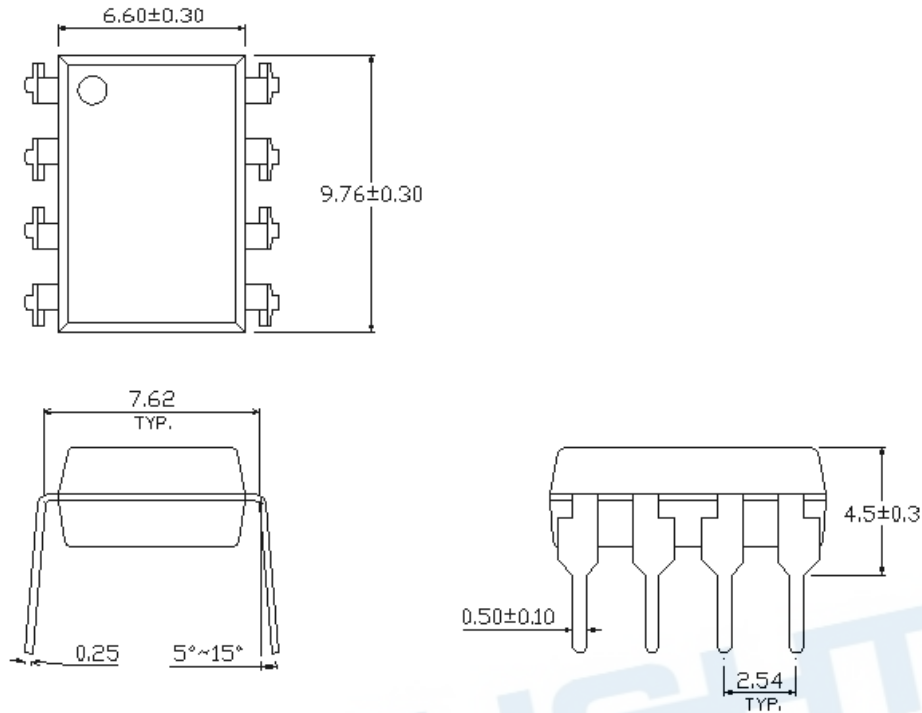
Note

- X = Part No. (X = 5 or 6) for 6N series; (X=2 or 3) for EL45 series
Y = Lead form option (S, S1, M or none)
Z = Tape and reel option (TA, TB or none)
V = VDE (optional)

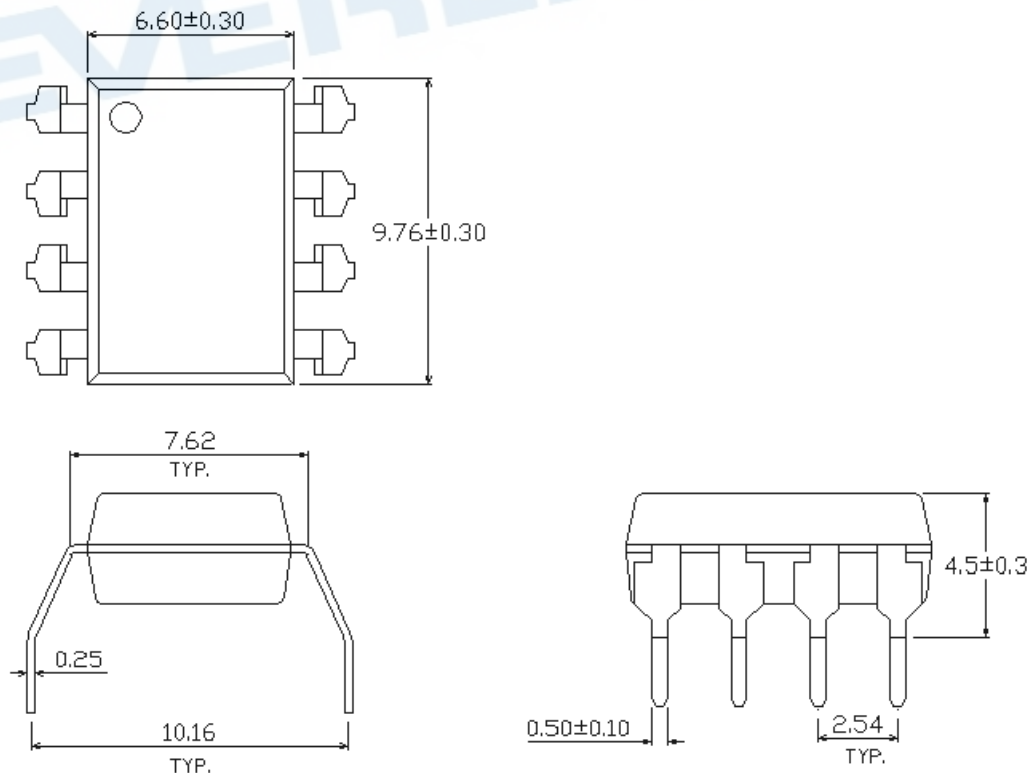
Option	Description	Packing quantity
None	Standard DIP-8	45 units per tube
M	Wide lead bend (0.4 inch spacing)	45 units per tube
S (TA)	Surface mount lead form + TA tape & reel option	1000 units per reel
S (TB)	Surface mount lead form + TB tape & reel option	1000 units per reel
S1 (TA)	Surface mount lead form (low profile) + TA tape & reel option	1000 units per reel
S1 (TB)	Surface mount lead form (low profile) + TB tape & reel option	1000 units per reel

Package Dimension (Dimensions in mm)

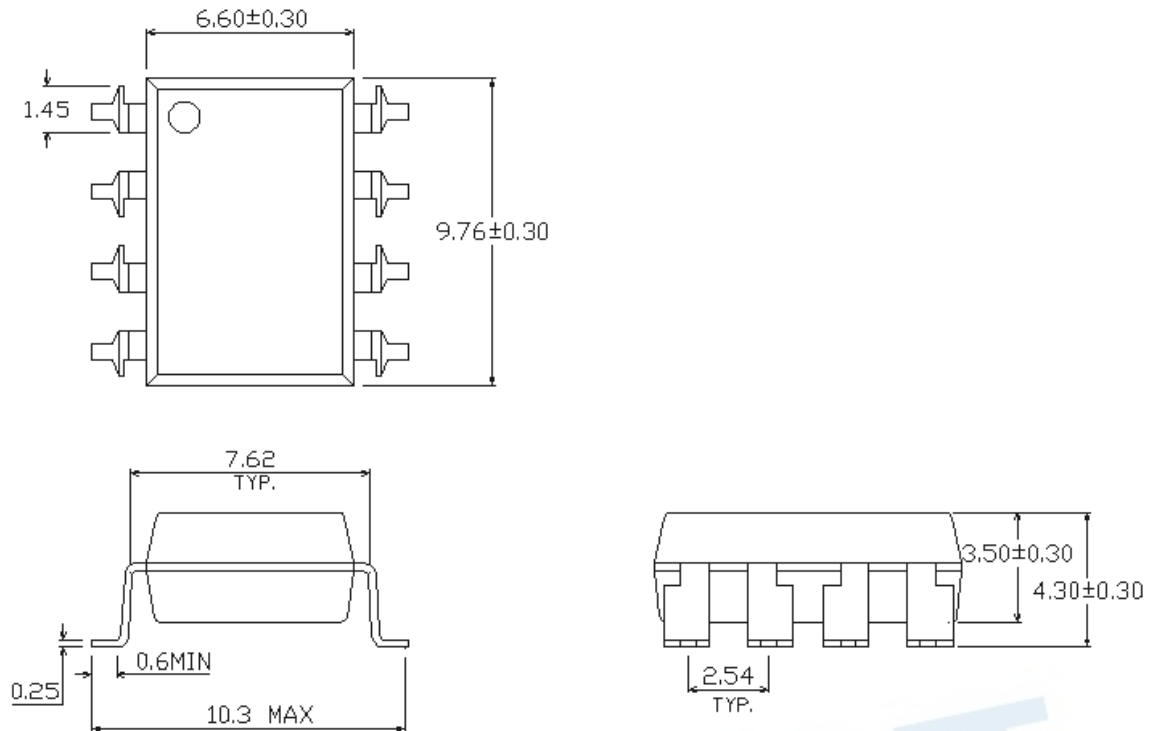
Standard DIP Type



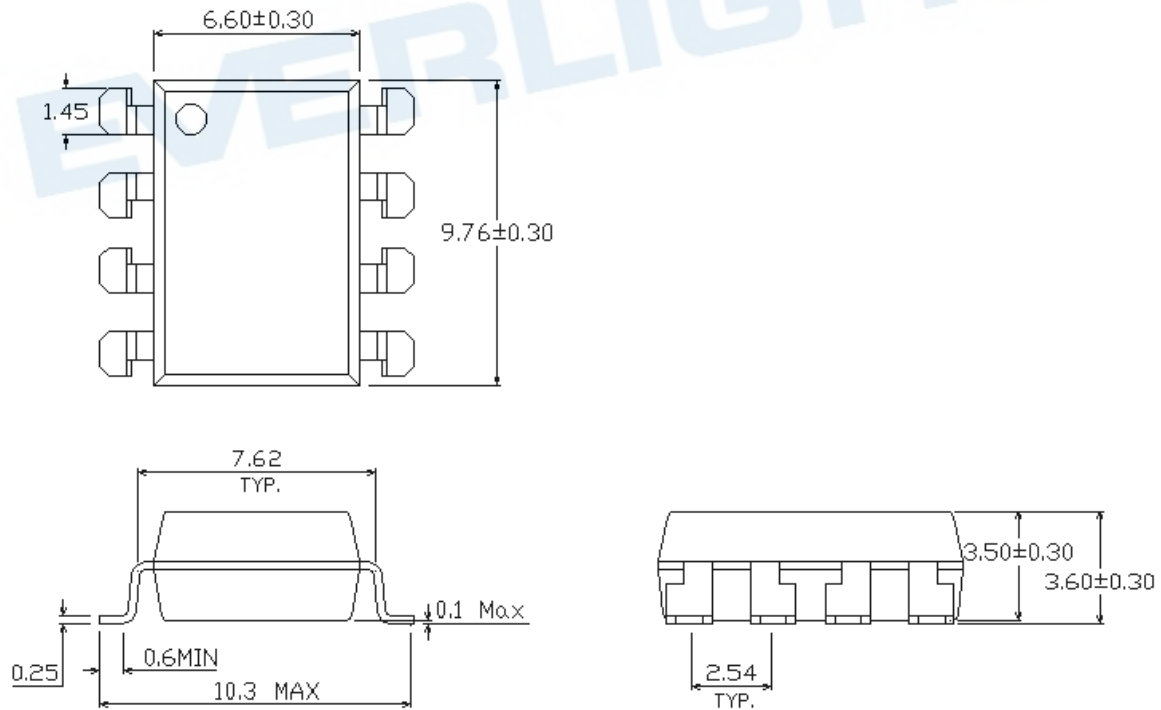
Option M Type



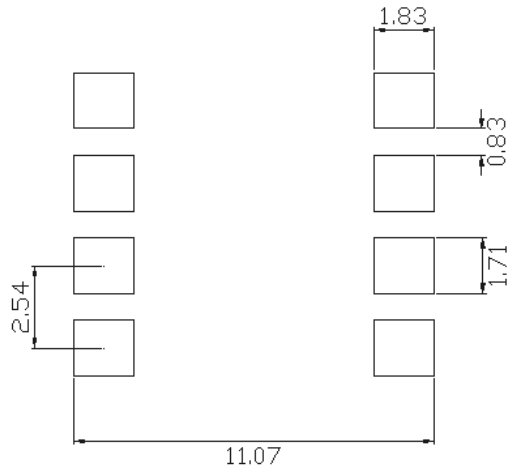
Option S Type



Option S1 Type



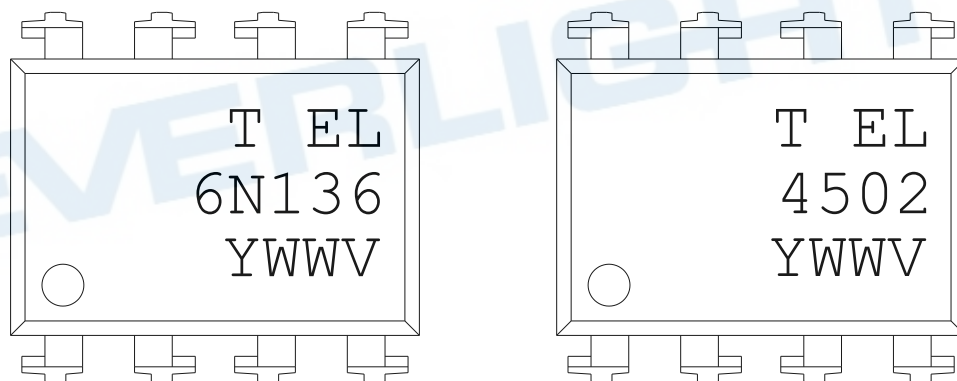
Recommended pad layout for surface mount leadform



Notes.

Suggested pad dimension is just for reference only.
Please modify the pad dimension based on individual need.

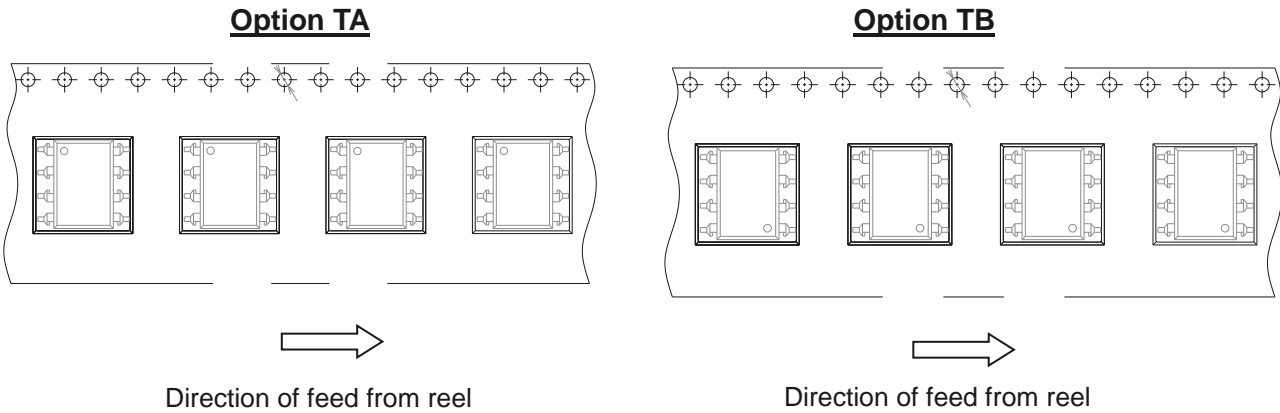
Device Marking



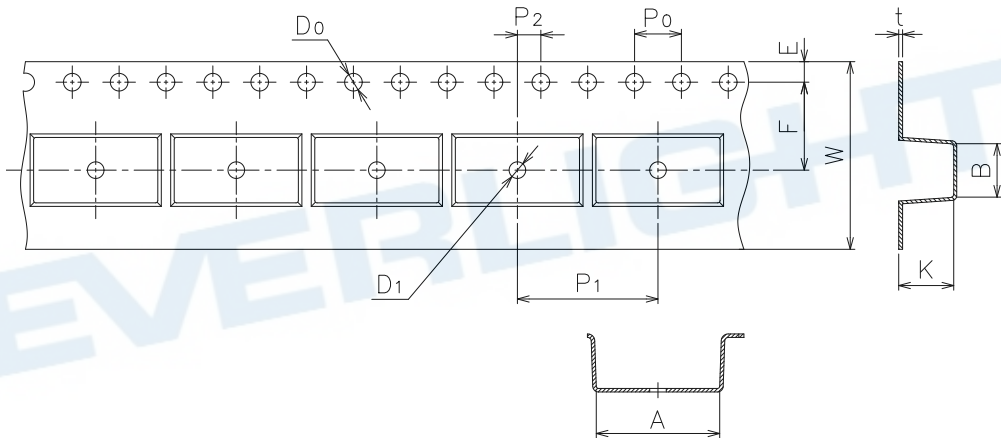
Notes

T	denotes Factory No code : made in China T : made in Taiwan
EL	denotes EVERLIGHT
4502	denotes Device Number
6N136	denotes Device Number
Y	denotes 1 digit Year code
WW	denotes 2 digit Week code
V	denotes VDE (optional)

Tape & Reel Packing Specifications



Tape dimensions

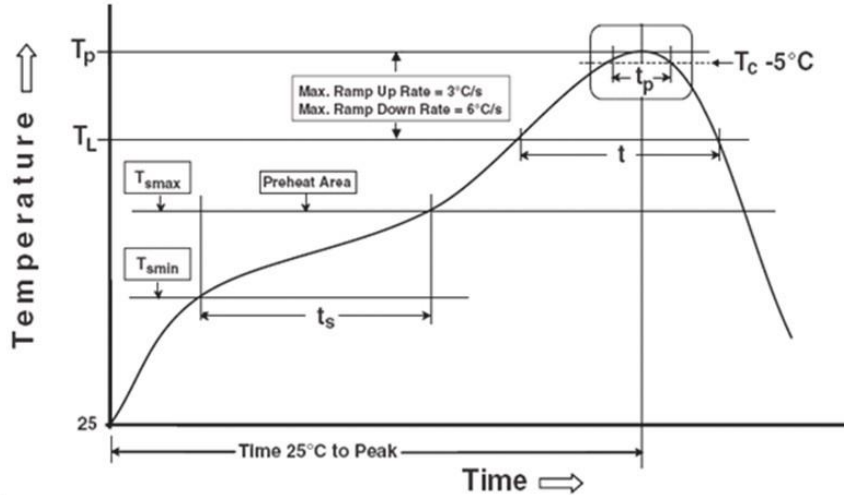


Dimension No.	A	B	Do	D1	E	F
Dimension(mm)	10.4±0.1	10.0±0.1	1.5+0.1/-0	1.5±0.25	1.75±0.1	7.5±0.1
Dimension No.	Po	P1	P2	t	W	K
Dimension(mm)	4.0±0.1	12.0±0.1	2.0±0.05	0.4±0.05	16.0±0.3	4.5±0.1

Precautions for Use

1. Soldering Condition

1.1 (A) Maximum Body Case Temperature Profile for evaluation of Reflow Profile



Note:

Reference: IPC/JEDEC J-STD-020D

Preheat

Temperature min (T_{smin})	150 °C
Temperature max (T_{smax})	200°C
Time (T_{smin} to T_{smax}) (t_s)	60-120 seconds
Average ramp-up rate (T_{smax} to T_P)	3 °C/second max

Other

Liquidus Temperature (T_L)	217 °C
Time above Liquidus Temperature (t_L)	60-100 sec
Peak Temperature (T_P)	260°C
Time within 5 °C of Actual Peak Temperature: $T_P - 5^\circ\text{C}$	30 s
Ramp- Down Rate from Peak Temperature	6°C /second max.
Time 25°C to peak temperature	8 minutes max.
Reflow times	3 times

DISCLAIMER

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